

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Hiroynid Nishi et al.

Docket No.

SKI.007D

Serial No.

09/893,455

AUG 15 2003

Filing Date

June 29, 2001

Examiner

A. Ortiz

Group Art Unit

1732

Invention: TRANSFER DUMPING APPARATUS AND METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICES (To Be Amended)

TO THE COMMISSIONER FOR PATENTS:

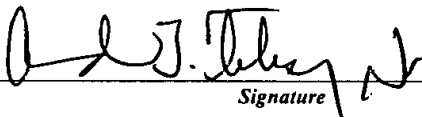
Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	18 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	4 -	3 =	1 x	\$84.00	\$84.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$84.00

- ☐ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
- ☒ A check in the amount of \$84.00 to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 50-0238
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.



Signature

Dated: August 15, 2003

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I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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TC 1700

Serial No. 09/893,455
SKI.007D

Amendment dated August 15, 2003

#69/BM
8/2/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Hiroyuki Nishi et al.

Group Art Unit: 1732

Serial No.: 09/893,455

Examiner: A. Ortiz

Filed: June 29, 2001

For: TRANSFER MOLDING APPARATUS AND METHOD FOR MANUFACTURING
SEMICONDUCTOR DEVICES (To Be Amended)

AMENDMENT

U.S. Patent and Trademark Office
2011 South Clark Place
Customer Window, **Mail Stop Fee Amendment**
Crystal Plaza Two, Lobby, Room 1B03
Arlington, VA 22202

Date: August 15, 2003

Sir:

In response to the Office Action dated May 21, 2003, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 4 of this paper.

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SKI.007D
Amendment dated August 15, 2003

Remarks/Arguments begin on page 10 of this paper.